IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Harold S. Gross

§ GROUP ART UNIT: 1765

SERIAL NO.: 10/006,306

8 **EXAMINER:** Unknown

FILED: December 6, 2001

LAYERS OXIDE THERMAL FOR: THICK

ISOLATION REGIONS IN A SILICON-CONTAINING SUBSTRATE FOR HIGH VOLTAGE APPLICATIONS

§ Attorney Docket No.:

§ AM-5846 RECEIVED

Date: May 31, 2000 1/N 9 6 2997

INFORMATION DISCLOSURE STATEMENT TRANSMITTAL LETTER

Hon. Commissioner for Patents Washington, DC 20231

Sir:

Applicants are submitting the subject Information Disclosure Statement under 37 CFR § 1.97(b)(3). This Information Disclosure Statement is being submitted prior to the first Office Action in the subject patent application.

CERTIFICATE OF MAILING UNDER 37 CFR § 1.10

I hereby certify that this paper is being deposited with the U.S. Postal Service on the date shown below with sufficient postage as U.S. EXPRESS MAIL NO. EU016348853US in an envelope addressed to the: Commissioner for Patents, Box DD, Washington, DC 20231.

Date: May 31, 2002

Shirley L. Church, Reg. No. 31,858

Applicants do not believe that any fee is due in connection with the filing of this Information Disclosure Statement under 37 CFR § 1.97(b)(3). However, in the event that any additional fee is due, the Commissioner is hereby authorized to charge Deposit Account No. <u>50-1512</u> of Shirley L. Church, Sunnyvale, California, in the amount of such fee.

This transmittal letter is submitted in duplicate for accounting purposes.

Respectfully submitted,

Shirley L. Church

Registration No. 31,858

Attorney for Applicants Correspondence Address:

Applied Materials, Inc. P.O. Box 450-A

Patent Counsel

Santa Clara, California 95052